

Features

1. Fast switching speed
2. Surface mount package ideally suited for automatic insertion
3. For general purpose switching applications
4. High conductance

Mechanical Data

Case : JEDEC SOD-323 molded plastic body

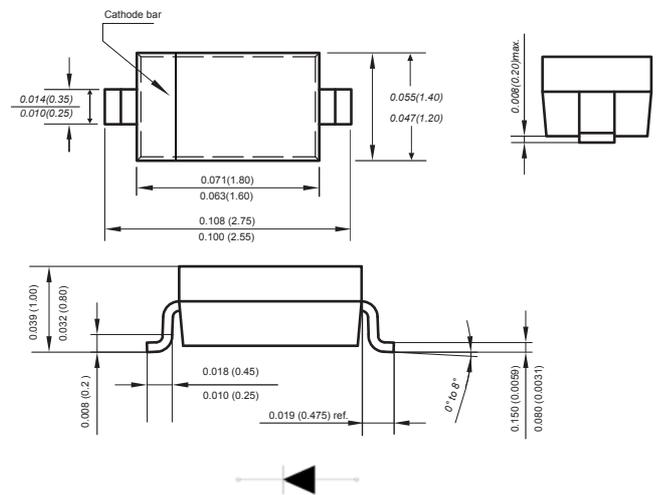
Terminals : Plated leads solderable per MIL-STD-750, Method 2026

Polarity : Polarity symbols marked on case

Weight : 0.0007 ounce, 0.02 grams

Marking: T4

SOD_323



Dimensions in inches and (millimeters)

Absolute Maximum Ratings at 25 °C

PARAMETER	SYMBOLS	Limits	UNITS
Maximum repetitive peak reverse voltage	V_{RRM}	100	V
Maximum RMS voltage	V_{RMS}	75	
Reverse Breakdown voltage at $I_R=1\mu A$	$V_{(BR)R}$	75	
Forward continuous current	I_{FM}	300	mA
Average rectified output current	I_o	150	mA
Peak forward current @=1.0MS	I_{FSM}	4.0	A
Power dissipation	P_d	400	mW
Thermal resistance junction to ambient	$R_{\theta JA}$	250	°C/W
Junction temperature	T_j	125	°C
Storage temperature	T_{STG}	-55 to +150	°C

Characteristics at $T_a=25\text{ }^{\circ}\text{C}$

PARAMETER	SYMBOLS	Min.	Typ.	Max.	Unit	Conditions
Forward voltage	V_{F1}			0.715	V	$I_F=1.0\text{mA}$
	V_{F2}			0.855	V	$I_F=10\text{mA}$
	V_{F3}			1.0	V	$I_F=50\text{mA}$
	V_{F4}			1.25	V	$I_F=150\text{mA}$
Reverse current	I_{R1}			0.025	μA	at $V_R=20\text{V}$ $T_j=25\text{ }^{\circ}\text{C}$
	I_{R2}			1	μA	at $V_R=75\text{V}$ $T_j=25\text{ }^{\circ}\text{C}$
	I_{R3}			30	μA	at $V_R=25\text{V}$ $T_j=150\text{ }^{\circ}\text{C}$
	I_{R4}			50	μA	at $V_R=75\text{V}$ $T_j=150\text{ }^{\circ}\text{C}$
Capacitance between terminals	C_T			5	pF	$V_R=0\text{V}$, $f=1.0\text{MHz}$
Reverse recovery time	t_{rr}			8	ns	$I_F=I_R=10\text{mA}$ $I_{rr}=0.1X I_R$, $R_L=100\ \Omega$

Typical Characteristics

Fig.1 Forward Current Derating Curve

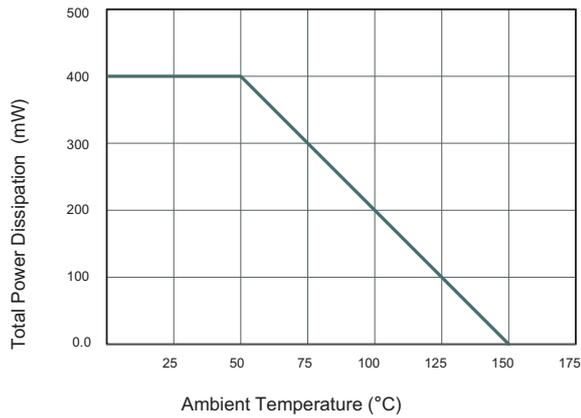


Fig.2 Typical Reverse Characteristics

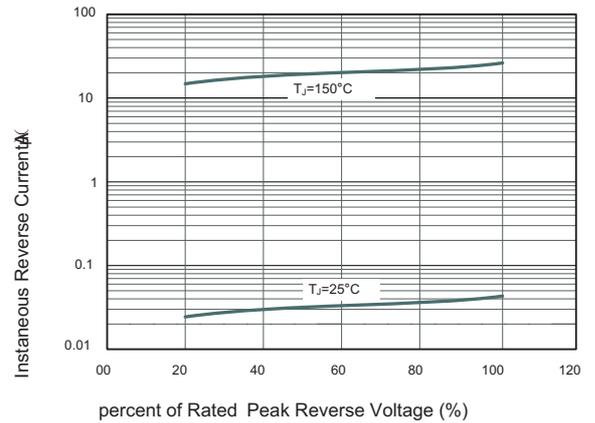


Fig.3 Typical Instantaneous Forward

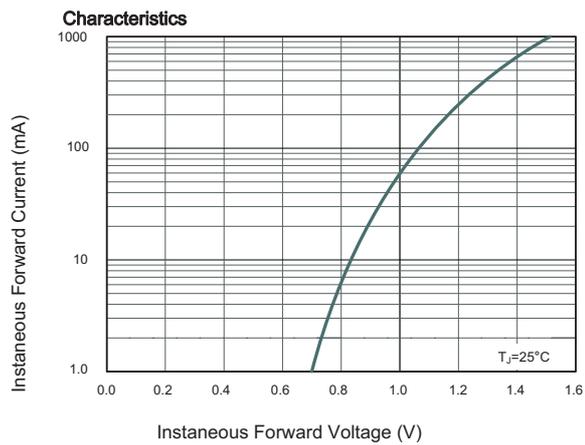
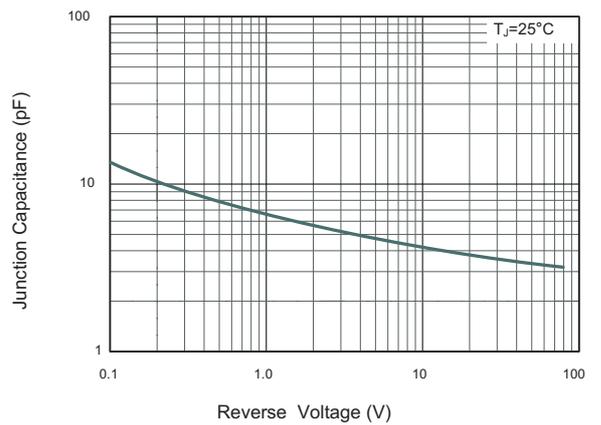
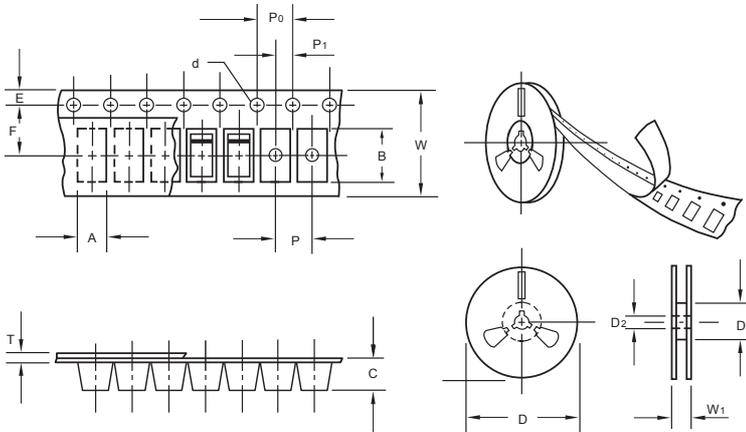


Fig.4 Typical Junction Capacitance



Packing information



unit:mm

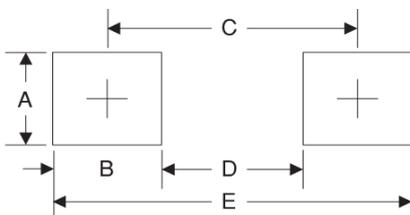
Item	Symbol	Tolerance	SOD-323
Carrier width	A	0.1	2.1
Carrier length	B	0.1	4.0
Carrier depth	C	0.1	1.60
Sprocket hole	d	0.05	1.55
7" Reel outside diameter	D	2.0	178.00
7" Reel inner diameter	D ₁	min	50.0
Feed hole diameter	D ₂	0.5	13.00
Sprocket hole position	E	0.1	1.75
Punch hole position	F	0.1	3.50
Punch hole pitch	P	0.1	4.00
Sprocket hole pitch	P ₀	0.1	4.00
Embossment center	P ₁	0.1	2.00
Overall tape thickness	T	0.1	0.25
Tape width	W	0.3	8.15
Reel width	W ₁	1.0	10.5

Note: Devices are packed in accordance with EIA standard RS-481-A and specifications listed above.

Reel packing

PACKAGE	REEL SIZE	REEL (pcs)	COMPONENT SPACING (m/m)	BOX (pcs)	INNER BOX (m/m)	REEL DIA, (m/m)	CARTON SIZE (m/m)	CARTON (pcs)	APPROX. GROSS WEIGHT (kg)
SOD-323	7"	3,000	4.0	45,000	210*208*203	178	430*430*235	180,000	

Suggested Pad Layout



Symbol	Unit (mm)	Unit (inch)
A	0.7	0.028
B	0.7	0.028
C	2.15	0.085
D	1.8	0.071
E	2.85	0.112